

Student Travel Grant Application San Francisco, CA

The Society's, Battery, Corrosion, Dielectric Science & Technology, Electrodeposition, Electronics and Photonics, Energy Technology, High Temperature Materials (HTM), Fullerenes, Nanotubes and Carbon Nanostructures (FNCN), Industrial Electrochemistry & Electrochemical Engineering (IE&EE), Luminescence and Display Materials (LDM), Organic and Biological Electrochemistry (O&BE), Physical and Analytical Electrochemistry, and Sensor Divisions offer travel grants to students presenting papers at the Society's next meeting in San Francisco, CA, October 27-November 1, 2013. **To apply, complete this application and send it along with a copy of your transcript and a letter from an involved faculty member attesting both to the quality of the student's work and financial needs, and a copy of the student's meeting abstract.** For additional information please contact the Division contact below, as requirements might differ among Divisions.

Meeting Site: _____

Name: _____

School Address: _____

Email: _____ Phone #: _____

Undergraduate Year (U) or Graduate Year (G) - circle one: U3 U4 G1 G2 G3 G4 G5

Major Subject: _____ Grade point average: _____ out of possible: _____

(please provide a letter of recommendation from your faculty advisor and a copy of your transcript)

Symposium Title (#): _____

Title of paper to be presented at the meeting: _____

Are you an ECS Student Member of the Society? yes no

(if not, please additionally submit the Awarded Student Membership application)

Estimated meeting expenditures: \$ _____

Signature: _____ Date: _____

Check only one Division. (*Applications made to multiple Divisions will be rejected.*)

- Battery—*Send to:* Marca Doeff, Lawrence Berkeley National Laboratory, 1 Cyclotron Rd., M/S 62R0100, Berkeley, CA 94720-8028, e-mail: mmdoeff@lbl.gov
- Corrosion—*Send to:* N. Missert, Sandia National Labs, MS 1415, P. O. Box 5800, Albuquerque, NM 87185-0100, USA, e-mail: namisse@sandia.gov
- Dielectric Science & Technology—*Send to:* Vimal Desai Chaitanya, New Mexico State University, Office of the VP for Research MSC 3RES - Box 30001, Las Cruces, NM 88003-8001, USA, e-mail: vimalc@nmsu.edu
- Electrodeposition—*Send to:* Natasa Vasiljevic, University of Bristol, H. H. Willis Physics Lab Rm. M21, Tyndal Avenue, Bristol, BS8 1TL, United Kingdom, e-mail: N.Vasiljevic@bristol.ac.uk
- Electronics and Photonics—*Send to:* Pablo Chang, Northrop Grumman, 1 Space Park Blvd. # D1/1050D, Redondo Beach, CA 90278-1001, USA, e-mail: pablo.chang@avagotech.com
- Energy Technology—*Send to:* Jean St. Pierre, University of Hawaii at Manoa, Hawaii Natural Energy Institute, 1680 East West Rd. POST 109, Honolulu, HI 96822, USA, e-mail: jsp7@hawaii.edu
- Fullerenes/Nanocarbons—*Send to:* Bruce Weisman, Rice University, Chemistry MS 60, 6100 Main Street. Houston, TX 77005, USA, e-mail: weisman@rice.edu
- HTM—*Send to:* Greg Jackson, Professor and Head, Department of Mechanical Engineering, Colorado School of Mines, Brown Hall W350, Golden, CO 80401, USA, e-mail: gsjackso@mines.edu
- IE&EE—*Send to:* John Staser, Cond La Ciudadela 602, Ave., Las Cumbres #2, Guaynabo, 00969 Puerto Rico, e-mail: staser.john@gmail.com
- LDM—*Send to:* John Collins, Wheaton College, Dept. of Physics & Astronomy, 26 East Main Street, Norton, MA, 02766-0000, USA, e-mail: jcollins@wheatonma.edu
- O&BE—*Send to:* James D. Burgess, Case Western Reserve University, 10900 Euclid Ave, Cleveland, OH 44106-1712, USA, e-mail: jdb22@case.edu
- Physical and Analytical Electrochemistry—*Send to:* Andrew Hillier, Professor and Associate Chair, Dept. of Chemical and Biological Engineering, 2122 Sweeney Hall, Iowa State University, Ames, IA 50011, USA, e-mail: hillier@mail.iastate.edu
- Sensor—*Send to:* Praveen K. Sekhar, Washington State University, PO Box 641020, Pullman, WA 99164-1020, USA, e-mail: praveen.sekhar@vancouver.wsu.edu

Applications for Travel Grants for the San Francisco, CA, meeting must be received no later than May 17, 2013.

www.electrochem.org/sponsorship/travel_grants.htm